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AMENDMENTS TO THE CLAIMS

1-11. (Cancelled)

12. (Currently Amended) A heat-dissipating fin module comprising:

a heat-conductive base, which is installed on a heat-generating component of an

electronic device;

a plurality of first heat-dissipating fins, which are vertically installed at intervals on one

half side of the heat-conductive base, each of the first heat-dissipating fins having an arc surface

parallel to one another, and the space between adjacent first heat-dissipating fins forming a first

airflow space for providing a curved airflow path;

a plurality of second heat-dissipating fins, which are vertically installed at intervals on the

other half side of the heat-conductive base, each of the second heat-dissipating fins having an arc

surface parallel to one another but having curvature centers opposite to those of the first heat-

dissipating fins, and the space between adjacent second heat-dissipating fins forming a second

airflow space for providing a curved airflow path that does not cross the airflow path of the first

airflow space; and

at least one third heat-dissipating fin, which is vertically installed on the heat-conductive

base in an outer region between the first heat-dissipating fins and the second heat-dissipating

fins; and

wherein, the curvature centers of the first heat-dissipating fins and the second heat-

dissipating fins are on a same line, the outermost first heat-dissipating fin and second heat-

dissipating fin are shorter, and the third heat-dissipating fin is straight.

Birch, Stewart, Kolasch & Birch, LLP

Application No. 10/667,369 Amendment dated November 17, 2005

Reply to Office Action of August 18, 2005

13-17. (Cancelled)

18. (Original) The heat-dissipating fin module of claim 12, wherein the first heat-

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dissipating fins, the second heat-dissipating fins, and the third heat-dissipating fins are formed on

the heat-conductive base by cutting and squeezing.

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